

Day : Wednesday

Date: 12/8/2004

Time: 12:56:07

PALM INTRANET

Inventor Name Search Result

Your Search was:

Last Name = KIM

First Name = DONG-KUK

Application#	Patent#	Status	Date Filed	Title	Inventor Name 19
<u>10969407</u>	Not Issued	020	10/20/2004	RIGID-FLEXIBLE PCB HAVING COVERLAY MADE OF LIQUID CRYSTALLINE POLYMER AND FABRICATION METHOD THEREOF	KIM, DONG-KUK
<u>10944002</u>	Not Issued	030	09/20/2004	WAFER LEVEL CHIP STACK METHOD	KIM, DONG-KUK
<u>10916094</u>	Not Issued	020	08/10/2004	APPARATUS FOR STACKING SEMICONDUCTOR CHIPS, METHOD FOR MANUFACTURING SEMICONDUCTOR PACKAGE USING THE SAME AND SEMICONDUCTOR PACKAGE MANUFACTURED THEREBY	KIM, DONG-KUK
<u>10787679</u>	Not Issued	030	02/25/2004	SEMICONDUCTOR MULTI-CHIP PACKAGE AND FABRICATION METHOD	KIM, DONG-KUK
<u>10629937</u>	Not Issued	030	07/29/2003	APPARATUS FOR BONDING A CHIP USING AN INSULATING ADHESIVE TAPE	KIM, DONG-KUK
<u>10607600</u>	Not Issued	030	06/27/2003	DICING TAPE ATTACHING UNIT THAT CAN ATTACH PRE-CUT DICING TAPE AND GENERAL DICING TAPE TO WAFER AND IN-LINE SYSTEM HAVING THE DICING TAPE ATTACHING UNIT	KIM, DONG-KUK
<u>10283681</u>	Not Issued	041	10/29/2002	APPARATUS AND METHOD FOR WAFER BACKSIDE INSPECTION	KIM, DONG-KUK
<u>09974409</u>	<u>6662799</u>	150	10/09/2001	VERTICAL WAFER SAWING APPARATUS	KIM, DONG-KUK
<u>09007797</u>	Not	161	01/15/1998	THIN FILM ACTUATED	KIM, DONG-KUK

	Issued			MIRROR ARRAY AND METHOD FOR THE MANUFACTURING THEREOF	
<u>08877645</u>	<u>5936757</u>	150	06/17/1997	THIN FILM ACTUATED MIRROR ARRAY	KIM , DONG-KUK
<u>08877084</u>	<u>5900998</u>	150	06/17/1997	THIN FILM ACTUATED MIRROR ARRAY AND METHOD FOR THE MANUFACTURE THEREOF	KIM , DONG-KUK
<u>08865983</u>	Not Issued	161	05/30/1997	PIEZOELECTRIC GENERATOR FOR GENERATING ELECTRICITY USING PIEZOELECTRIC ELEMENTS ATTACHED TO A VIBRATION SOURCE AND METHOD FOR MANUFACTURING THE SAME	KIM , DONG-KUK
<u>08504874</u>	<u>5608569</u>	150	07/20/1995	METHOD FOR MANUFACTURING AN ARRAY OF THIN FILM ACTUATED MIRRORS	KIM , DONG-KUK
<u>08430628</u>	<u>5636070</u>	150	04/28/1995	THIN FILM ACTUATED MIRROR ARRAY	KIM , DONG-KUK
<u>08336021</u>	<u>5760947</u>	150	11/08/1994	THIN FILM ACTUATED MIRROR ARRAY FOR USE IN AN OPTICAL PROJECTION SYSTEM AND METHOD FOR THE MANUFACTURE THEREOF	KIM , DONG-KUK
<u>08331399</u>	<u>5661611</u>	150	10/28/1994	THIN FILM ACTUATED MIRROR ARRAY AND METHOD FOR THE MANUFACTURE THEREOF	KIM , DONG-KUK
<u>08278660</u>	<u>5505807</u>	150	07/21/1994	ACTUATED MIRROR ARRAY AND METHOD FOR THE FABRICATING THEREOF	KIM , DONG-KUK
<u>08239173</u>	<u>5758396</u>	150	05/04/1994	METHOD OF MANUFACTURING A PIEZOELECTRIC ACTUATOR ARRAY	KIM , DONG-KUK
<u>08216756</u>	<u>5606451</u>	150	03/23/1994	ELECTRODISPLACIVE ACTUATOR ARRAY AND METHOD FOR THE MANUFACTURE THEREOF	KIM , DONG-KUK

Inventor Search Completed: No Records to Display.

Last Name

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Day : Wednesday

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 PALM INTRANET**Inventor Name Search Result**

Your Search was:

Last Name = KIM

First Name = MIN-II

Application#	Patent#	Status	Date Filed	Title	Inventor Name 1
10629937	Not Issued	030	07/29/2003	APPARATUS FOR BONDING A CHIP USING AN INSULATING ADHESIVE TAPE	KIM, MIN-II

Inventor Search Completed: No Records to Display.

Search Another: Inventor	Last Name	First Name	Search
	<input type="text" value="kim"/>	<input type="text" value="min-ii"/>	

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PALM INTRANET**Inventor Name Search Result**

Your Search was:

Last Name = LEE

First Name = SANG-YEOP

Application#	Patent#	Status	Date Filed	Title	Inventor Name 5
10897098	Not Issued	030	07/23/2004	SEMICONDUCTOR CHIP PACKAGE AND STACKED MODULE HAVING A FUNCTIONAL PART AND PACKAGING PART ARRANGED ON A COMMON PLANE	LEE, SANG-YEOP
10885769	Not Issued	030	07/08/2004	WIRE BONDING METHOD, SEMICONDUCTOR CHIP, AND SEMICONDUCTOR PACKAGE	LEE, SANG-YEOP
10632700	Not Issued	041	07/31/2003	MULTI-CHIP MODULE HAVING BONDING WIRES AND METHOD OF FABRICATING THE SAME	LEE, SANG-YEOP
10629937	Not Issued	030	07/29/2003	APPARATUS FOR BONDING A CHIP USING AN INSULATING ADHESIVE TAPE	LEE, SANG-YEOP
10458281	Not Issued	061	06/11/2003	SEMICONDUCTOR CHIP PACKAGE HAVING AN ADHESIVE TAPE ATTACHED ON BONDING WIRES	LEE, SANG-YEOP

Inventor Search Completed: No Records to Display.

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<input type="text" value="lee"/>	<input type="text" value="sang-yeop"/>	<input type="button" value="Search"/>
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